

Part Number: WP1384AD/YD

Yellow

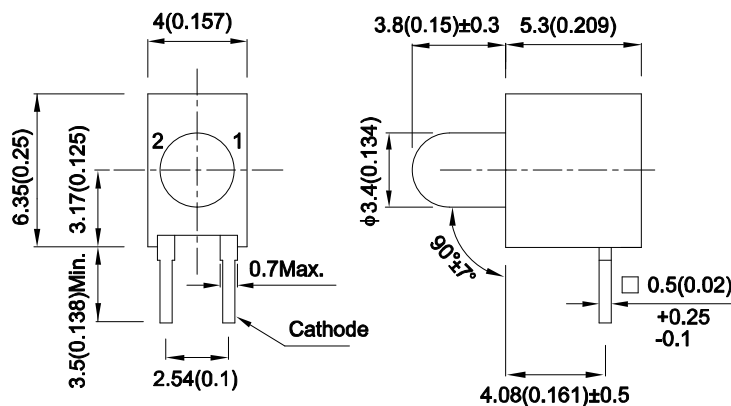
Features

- Ideal for card edge status indication
- Wide viewing angle
- High reliability-life measured in years
- Housing UL rating: 94V-0
- Housing material: type 66 nylon
- RoHS compliant

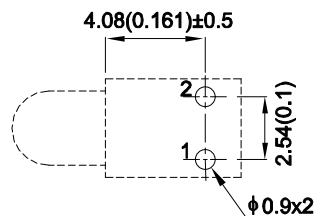
Description

The Yellow source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Yellow Light Emitting Diode.

Package Dimensions



Recommended PCB Layout



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.25(0.01)$ unless otherwise noted.
3. Lead spacing is measured where the leads emerge from the package.
4. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.



Selection Guide

| Part No. | Emitting Color (Material) | Lens Type | Iv (mcd) [2] @ 10mA | | Viewing Angle [1] |
|-------------|---------------------------|-----------------|------------------------|------|----------------------|
| | | | Min. | Typ. | 2θ1/2 |
| WP1384AD/YD | Yellow (GaAsP/GaP) | Yellow Diffused | 8 | 15 | 60° |

Notes:

1. $\theta 1 / 2$ is the angle from optical centerline where the luminous intensity is 1 / 2 of the optical peak value.
2. Luminous intensity / luminous Flux: + / -15%.
3. Luminous intensity value is traceable to CIE127-2007 standards.

Electrical / Optical Characteristics at TA=25°C

| Symbol | Parameter | Emitting Color | Typ. | Max. | Units | Test Conditions |
|-----------------------|--------------------------|----------------|------|------|-------|---------------------------|
| λ_{peak} | Peak Wavelength | Yellow | 590 | | nm | I _F =10mA |
| λ_D [1] | Dominant Wavelength | Yellow | 588 | | nm | I _F =10mA |
| $\Delta\lambda_{1/2}$ | Spectral Line Half-width | Yellow | 35 | | nm | I _F =10mA |
| C | Capacitance | Yellow | 20 | | pF | V _F =0V;f=1MHz |
| V _F [2] | Forward Voltage | Yellow | 1.95 | 2.5 | V | I _F =10mA |
| I _R | Reverse Current | Yellow | | 10 | uA | V _R = 5V |

Notes:

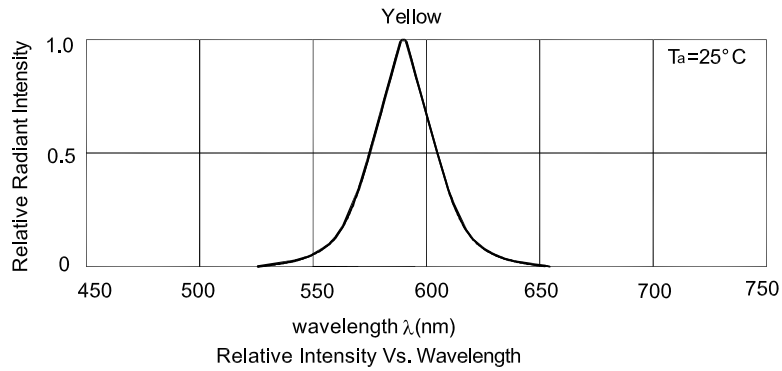
1. Wavelength: + / -1nm.
2. Forward Voltage: + / -0.1V.
3. Wavelength value is traceable to CIE127-2007 standards.
4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

| Parameter | Values | Units |
|-------------------------------|---------------------|-------|
| Power dissipation | 75 | mW |
| DC Forward Current | 30 | mA |
| Peak Forward Current [1] | 140 | mA |
| Reverse Voltage | 5 | V |
| Operating/Storage Temperature | -40°C To +85°C | |
| Lead Solder Temperature [2] | 260°C For 3 Seconds | |
| Lead Solder Temperature [3] | 260°C For 5 Seconds | |

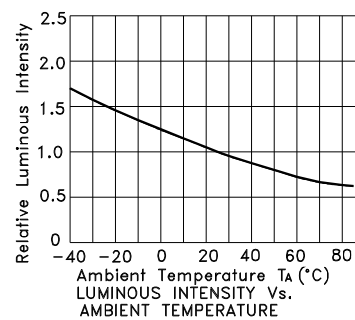
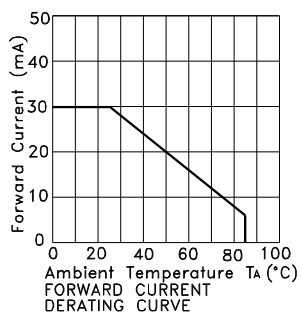
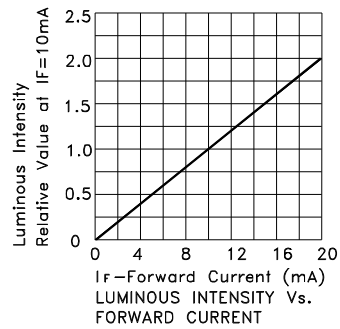
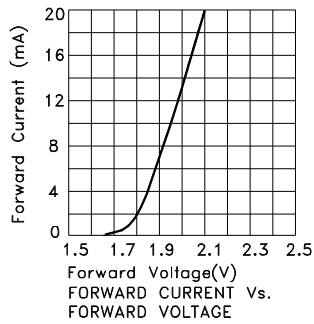
Notes:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. 2mm below package base.
3. 5mm below package base.
4. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.



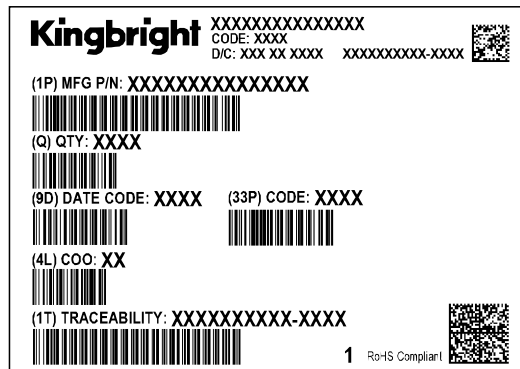
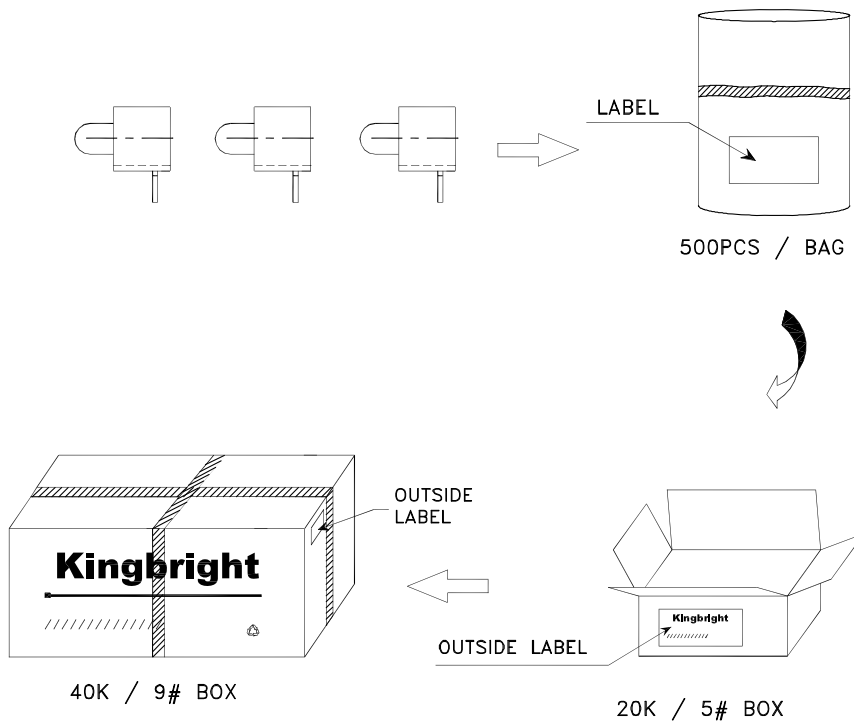
Yellow

WP1384AD/YD



PACKING & LABEL SPECIFICATIONS

WP1384AD/YD



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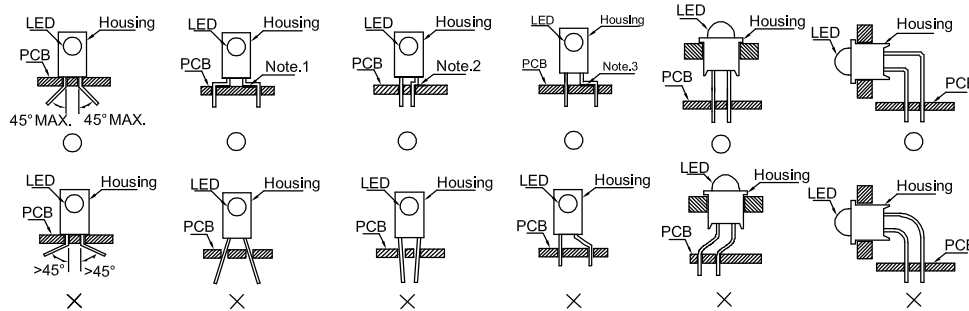
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PRECAUTIONS

1. Storage conditions:

- Continued exposure to the condensing moisture environment and keep the product away from rapid transitions in ambient temperature.
- LEDs should be stored with temperature $\leq 30^{\circ}\text{C}$ and relative humidity $< 60\%$.
- Product in the original sealed package is recommended to be assembled within 72 hours of opening. Product in opened package for more than a week should be baked for 30 (+10/-0) hours at $85 \sim 100^{\circ}\text{C}$.

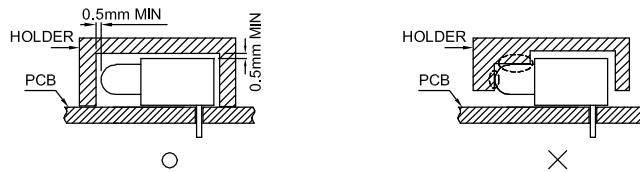
2. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures.



"○" Correct mounting method "X" Incorrect mounting method

Note 1-3: Do not route PCB trace in the contact area between the leadframe and the PCB to prevent short-circuits.

3. During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering.

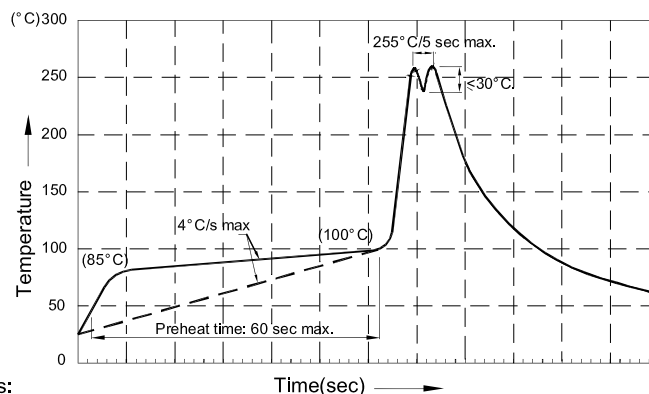


4. The tip of the soldering iron should never touch the lens epoxy.

5. Through-hole LEDs are incompatible with reflow soldering.

6. If the LED will undergo multiple soldering passes or face other processes where the part may be subjected to intense heat, please check with Kingbright for compatibility.

7. Recommended Wave Soldering Profiles:



Notes:

- Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C
- Peak wave soldering temperature between $245^{\circ}\text{C} \sim 255^{\circ}\text{C}$ for 3 sec (5 sec max).
- Do not apply stress to the epoxy resin while the temperature is above 85°C .
- Fixtures should not incur stress on the component when mounting and during soldering process.
- SAC 305 solder alloy is recommended.
- No more than one wave soldering pass.